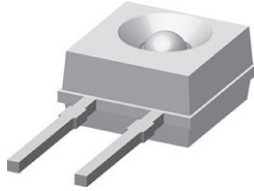


Infrared Emitting Diode, 950 nm, GaAs



14354

DESCRIPTION

The TSKS5400S is an infrared, 950 nm emitting diode in GaAs technology with high radiant power, molded in a clear plastic package.

FEATURES

- Package type: leaded
- Package form: side view lens
- Dimensions (L x W x H in mm): 5 x 2.65 x 5
- Peak wavelength: $\lambda_p = 950$ nm
- High reliability
- High radiant power
- High radiant intensity
- Angle of half intensity: $\phi = \pm 30^\circ$
- Low forward voltage
- Suitable for high pulse current operation
- Good spectral matching with Si photodetectors
- Package matched with detector TEKS5400
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Photointerrupters
- Transmissive sensors, gap sensors
- Reflective sensors

PRODUCT SUMMARY

| COMPONENT | I_e (mW/sr) | ϕ (deg) | λ_p (nm) | t_r (ns) |
|-----------|---------------|--------------|------------------|------------|
| TSKS5400S | 4.5 | ± 30 | 950 | 800 |

Note

- Test conditions see table "Basic Characteristics"

ORDERING INFORMATION

| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM |
|---------------|-----------|------------------------------|----------------|
| TSKS5400S | Bulk | MOQ: 2000 pcs, 2000 pcs/bulk | Side view lens |

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25^\circ\text{C}$, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|-------------------------------------|--|------------|---------------|------------------|
| Reverse voltage | | V_R | 6 | V |
| Forward current | | I_F | 100 | mA |
| Surge forward current | $t_p \leq 100 \mu\text{s}$ | I_{FSM} | 2 | A |
| Power dissipation | | P_V | 170 | mW |
| Junction temperature | | T_J | 100 | $^\circ\text{C}$ |
| Operating temperature range | | T_{amb} | - 25 to + 85 | $^\circ\text{C}$ |
| Storage temperature range | | T_{stg} | - 40 to + 100 | $^\circ\text{C}$ |
| Soldering temperature | $t \leq 5$ s, 2 mm from case | T_{sd} | 260 | $^\circ\text{C}$ |
| Thermal resistance junction/ambient | J-STD-051, leads 7 mm, soldered on PCB | R_{thJA} | 270 | K/W |

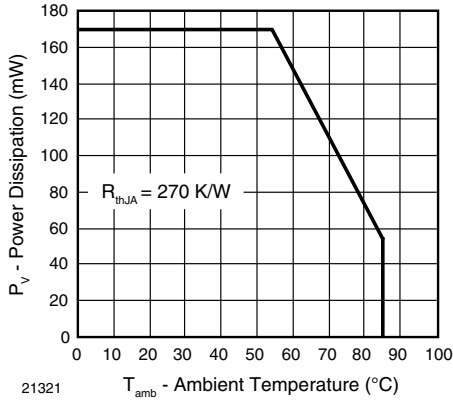


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

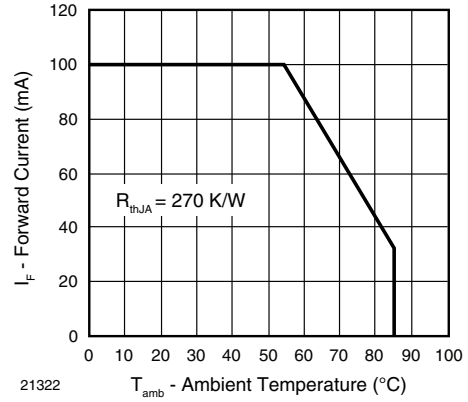


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) | | | | | | |
|--|--|-----------------|------|----------|------|-------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | $I_F = 100\text{ mA}$, $t_p \leq 20\text{ ms}$ | V_F | | 1.3 | 1.7 | V |
| Reverse voltage | $I_R = 10\text{ }\mu\text{A}$ | V_R | 6 | | | V |
| Temperature coefficient of V_F | $I_F = 100\text{ mA}$ | TK_{V_F} | | -1.3 | | mV/K |
| Junction capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0$ | C_j | | 50 | | pF |
| Radiant intensity | $I_F = 100\text{ mA}$, $t_p \leq 20\text{ ms}$ | I_e | 2 | 4.5 | 7 | mW/sr |
| Radiant power | $I_F = 50\text{ mA}$, $t_p \leq 20\text{ ms}$ | ϕ_e | | 10 | | mW |
| Temperature coefficient of ϕ_e | $I_F = 50\text{ mA}$ | TK_{ϕ_e} | | -1.0 | | %/K |
| Angle of half sensitivity | | ϕ | | ± 30 | | deg |
| Peak wavelength | $I_F = 50\text{ mA}$ | λ_p | | 950 | | nm |
| Spectral bandwidth | $I_F = 50\text{ mA}$ | $\Delta\lambda$ | | 50 | | nm |
| Rise time | $I_F = 100\text{ mA}$ | t_r | | 800 | | ns |
| | $I_F = 1\text{ A}$, $t_p/T = 0.01$, $t_p \leq 10\text{ }\mu\text{s}$ | t_r | | 450 | | ns |

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

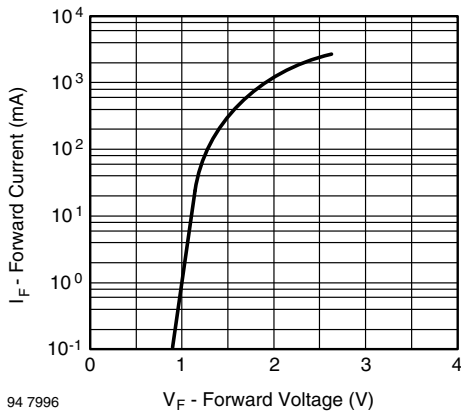


Fig. 3 - Pulse Forward Current vs. Forward Voltage

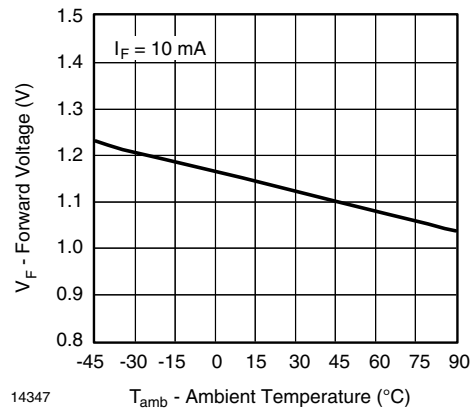


Fig. 4 - Forward Voltage vs. Ambient Temperature

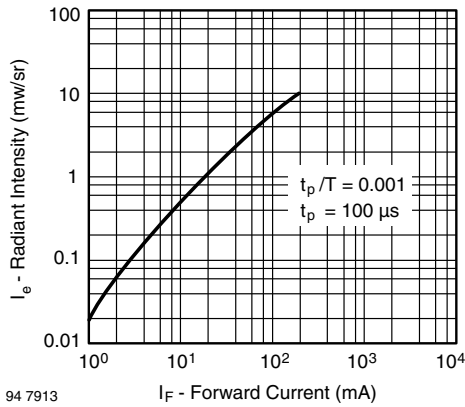


Fig. 5 - Radiant Intensity vs. Forward Current

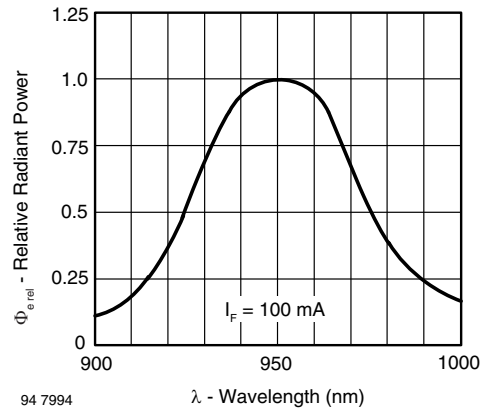


Fig. 8 - Relative Radiant Power vs. Wavelength

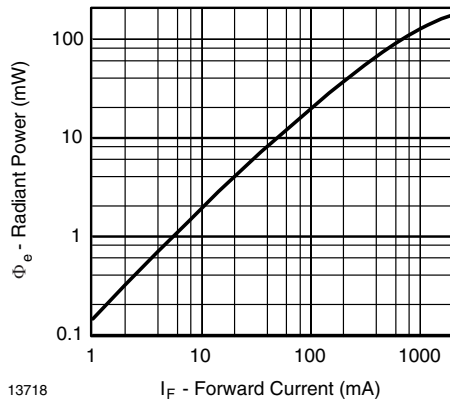


Fig. 6 - Radiant Power vs. Forward Current

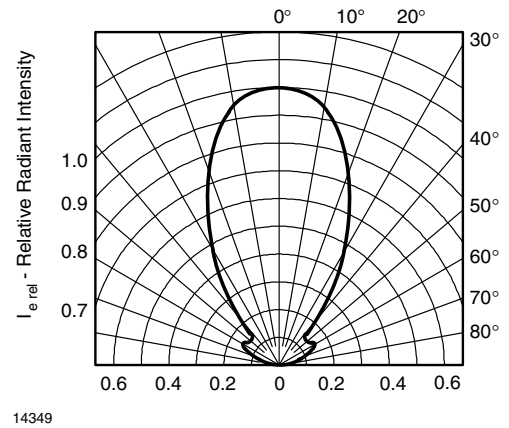


Fig. 9 - Relative Radiant Intensity vs. Angular Displacement

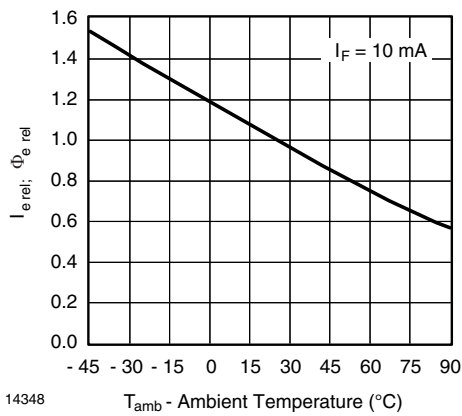
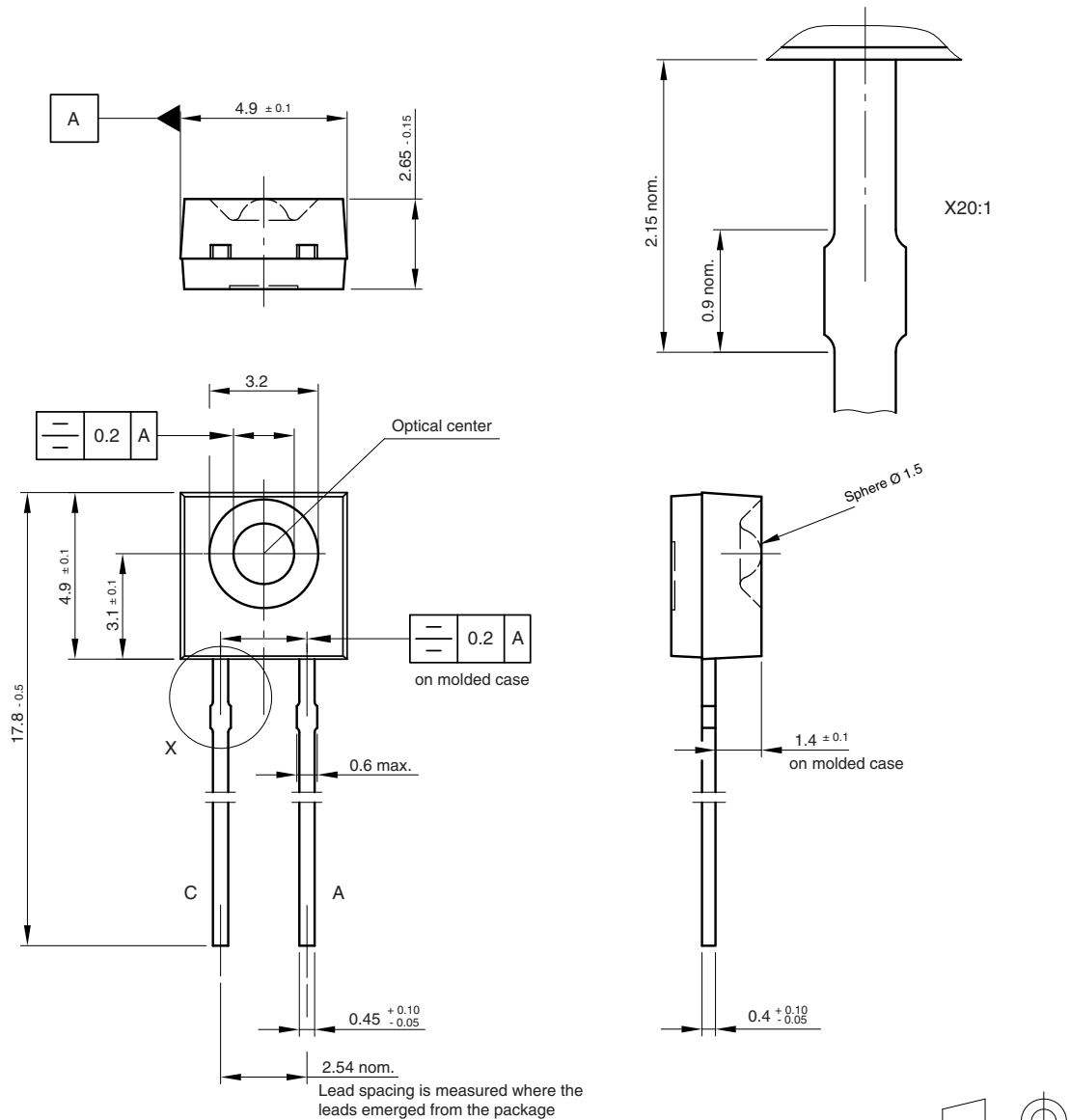


Fig. 7 - Relative Radiant Intensity vs. Ambient Temperature

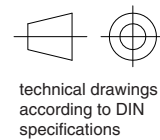


PACKAGE DIMENSIONS in millimeters

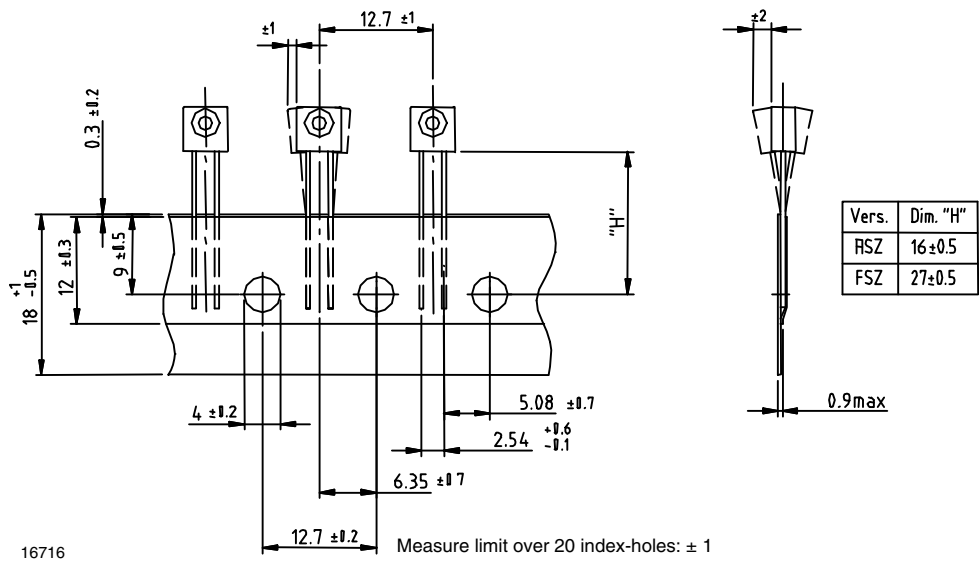
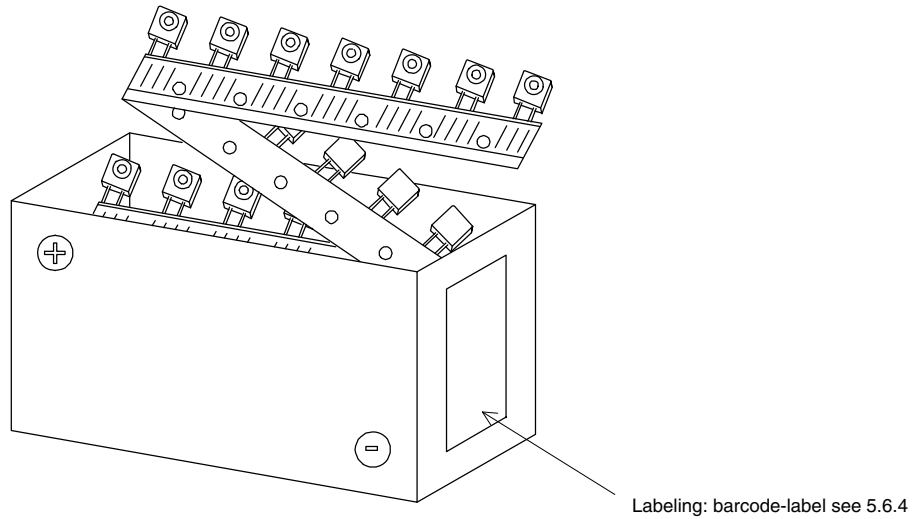


Protruded resin area where the leads emerged from the package 0.8 max.

Drawing-No.: 6.544-5306.51-4
Issue: 6; 04.07.02
14307



TAPE AND AMMOPACK STANDARDS DIMENSIONS in millimeters





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